

Declaration of Compliance

We declare that our green products for customer comply with all RoHS regulations. We are willing to provide all necessary documentation or information to prove our compliance with the RoHS regulations. It is our responsibility to proactively inform our customer if we identify that there is a potential risk of breaching the RoHS regulations in our product.

1. Product Information

Product Model P/N: SAF4101I

Product Description: ??Security Appliances SAF4101I-0416-ZZ , 1 N

2. Classification

Edge-Core Networks approve and follow the exclude article of EU RoHS for components and product.

- a. Full compliance with RoHS 2.0(2011/65/EU&(EU)2015/863&EN50581:2012)
Pb, Hg, Cr6+, PBB, PBDE,DEHP,DBP,BBP,DIBP < 1000 ppm, Cd < 100 ppm
- b. Full compliance with RoHS 2.0(2011/65/EU&(EU)2015/863&EN50581:2012)
Pb, Hg, Cr6+, PBB, PBDE,DEHP,DBP,BBP,DIBP < 1000 ppm, Cd < 100 ppm+PFOS(2006/122/EC)(PFOS < 1000 ppm)
- c. Partial compliance with RoHS 2.0(2011/65/EU) requirements (except Pb) (5/6)
Hg, Cr6+, PBB, PBDE < 1000 ppm, Cd < 100 ppm
- d. Full compliance with China RoHS requirements (Pb, Hg, Cr6+, PBB, PBDE < 1000 ppm, Cd < 100 ppm)
- e. Full compliance with Korea RoHS requirements (Pb, Hg, Cr6+, PBB, PBDE < 1000 ppm, Cd < 100 ppm)
- f. Full compliance with REACH(EC 1907/2006)requirements
- g. Full compliance with Taiwan RoHS-CNS 15663 requirements

RoHS :

Meet RoHS 2(2011/65/EU & (EU)2015/863) & PFOS(2006/122/EC) and use RoHS Exemption as below :

6c : Copper alloy containing up to 4 % lead by weight .

7a : Lead in high melting temperature type solders (i.e. lead- based alloys containing 85 % by weight or more lead) .

7c-I : Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.

REACH:

Meet REACH 181 SVHCs (Directive EC 1907/2006) and REACH SVHC material list follow ECHA web announce.

<http://echa.europa.eu/web/guest/candidate-list-table>

Name: 陳文輝 Wen Chen

Deputy Project Manager

QA Representative

Signature: 

Date: 2019/1/30